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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

YAMAMOTO et al.

Group Art Unit: Unknown

Application No.: Not yet Assigned

Examiner: Unknown

Filed: February 26, 2002

Attorney Dkt. No.: 108384-00043

For: MANUFACTURING PROCESS FOR PRINTED WIRING BOARD

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

February 26, 2002

Sir:

Prior to initial examination of the application, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend claims 9-11 as follows:

9. (Amended) The manufacturing process for a printed wiring board according to claim 5, characterized in that said organic layer is formed with one or two selected from the group consisting of nitrogen-containing organic compounds, sulfur-containing organic compounds and carboxylic acids.

10. (Amended) The manufacturing process for a printed wiring board according to claim 5, characterized in that said organic layer is formed by repeatedly applying an organic agent constituted of one or constituted as a mixture of two or more selected

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